

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Daisuke Kawagoe Examiner: Ishwar B. Patel

PATENT

Serial No.:

10/646,478

Group Art Unit: 2841

Filed:

August 22, 2003

Docket No.: 884.937US1

Title:

STACKED VIA STRUCTURE THAT INCLUDES A SKIP VIA

Intel Corporation Assignee:

Customer Number: 21186

AMENDMENT & RESPONSE UNDER 37 C.F.R. 1.116

Mail Stop AF Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

In response to the Final Office Action mailed June 29, 2005, please amend the application as follows: